PCA9554

8-bit I²C and SMBus I/O Port with Interrupt

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TSSOP−16
Y SUFFIX
CASE 948AN

Description

The PCA9554 is a CMOS device that provides 8−bit parallel input/output port expansion for I²C and SMBus compatible applications. This I/O expander provides a simple solution in applications where additional I/Os are needed: sensors, power switches, LEDs, pushbuttons, and fans.

The PCA9554 consist of an input port register, an output port register, a configuration register, a polarity inversion register and an I²C/SMBus−compatible serial interface.

Any of the eight I/Os can be configured as an input or output by writing to the configuration register. The system master can invert the PCA9554 input data by writing to the active−high polarity inversion register.

The PCA9554 features an active low interrupt output which indicates to the system master that an input state has changed.

The device's extended addressing capability allows up to 8 devices to share the same bus.

Features

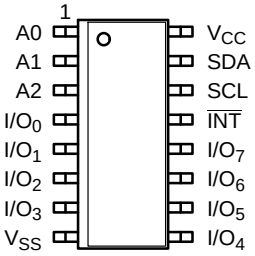
- 400 kHz I²C Bus Compatible (Note 1)
- 2.3 V to 5.5 V Operation
- Low Standby Current
- 5 V Tolerant I/Os
- 8 I/O Pins that Default to Inputs at Power−up
- High Drive Capability
- Individual I/O Configuration
- Polarity Inversion Register
- Active Low Interrupt Output
- Internal Power−on Reset
- No Glitch on Power−up
- Noise Filter on SDA/SCL Inputs
- Cascadable up to 8 Devices
- Industrial Temperature Range
- 16−lead TSSOP Package
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- White Goods (dishwashers, washing machines)
- Handheld Devices (cell phones, PDAs, digital cameras)
- Data Communications (routers, hubs and servers)

1. All I/Os are set to inputs at RESET.

PIN CONNECTIONS



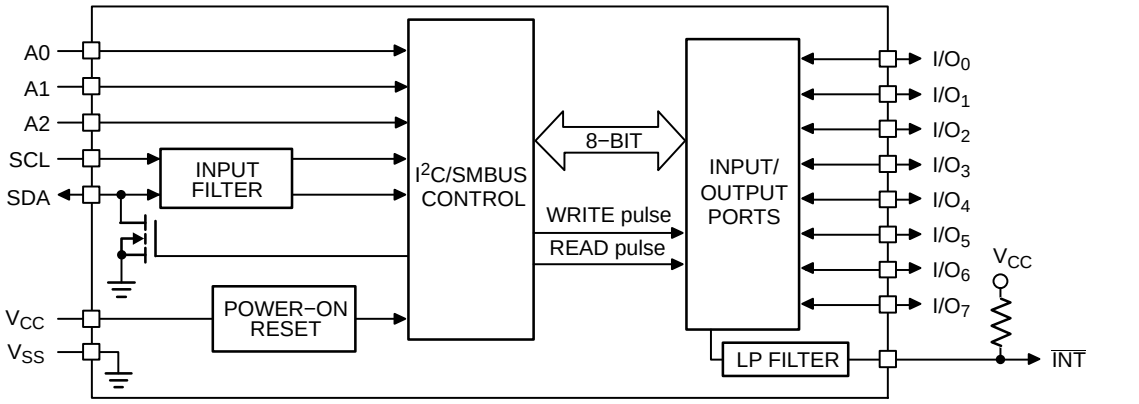
TSSOP (Y)
(Top View)

ORDERING INFORMATION

Device	Package	Shipping†
PCA9554DTR2G	TSSOP16 (Pb−Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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Note: All I/Os are set to inputs at RESET.

Figure 1. Block Diagram

Table 1. PIN DESCRIPTION

TSSOP	Pin Name	Function
1	A0	Address Input 0
2	A1	Address Input 1
3	A2	Address Input 2
4−7	I/O_{0-3}	Input/Output Port 0 to Input/Output Port 3
8	V_{SS}	Ground
9−12	I/O_{4-7}	Input/Output Port 4 to Input/Output Port 7
13	$\overline{INT}$	Interrupt Output (open drain)
14	SCL	Serial Clock
15	SDA	Serial Data
16	V_{CC}	Power Supply

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameters	Ratings	Units
V_{CC} with Respect to Ground	−0.5 to +6.5	V
Voltage on Any Pin with Respect to Ground	−0.5 to +5.5	V
DC Current on I/O_0 to I/O_7	±50	mA
DC Input Current	±20	mA
V_{CC} Supply Current	85	mA
V_{SS} Supply Current	100	mA
Package Power Dissipation Capability (T_A = 25°C)	1.0	W
Junction Temperature	+150	°C
Storage Temperature	−65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 3. RELIABILITY CHARACTERISTICS

Symbol	Parameter	Reference Test Method	Min	Units
V_{ZAP} (Note 2)	ESD Susceptibility	JEDEC Standard JESD 22	2000	Volts
I_{LTH} (Notes 2, 3)	Latch−up	JEDEC Standard 17	100	mA

2. This parameter is tested initially and after a design or process change that affects the parameter.
3. Latch−up protection is provided for stresses up to 100 mA on address and data pins from −1 V to V_{CC} +1 V.

Table 4. D.C. OPERATING CHARACTERISTICS (V_{CC} = 2.3 to 5.5 V; T_A = −40°C to +85°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
SUPPLIES						
V_{CC}	Supply voltage		2.3	−	5.5	V
I_{CC}	Supply current	Operating mode; V_{CC} = 5.5 V; no load; f_{SCL} = 100 kHz	−	104	175	μA
I_{stbl}	Standby current	Standby mode; V_{CC} = 5.5 V; no load; V_I = V_{SS}; f_{SCL} = 0 kHz; I/O = inputs	−	550	700	μA
I_{stbh}	Standby current	Standby mode; V_{CC} = 5.5 V; no load; V_I = V_{CC}; f_{SCL} = 0 kHz; I/O = inputs	−	0.25	1	μA
V_{POR}	Power−on reset voltage	No load; V_I = V_{CC} or V_{SS}	−	1.5	1.65	V
SCL, SDA, $\overline{INT}$						
V_{IL} (Note 4)	Low level input voltage		−0.5	−	0.3 x V_{CC}	V
V_{IH} (Note 4)	High level input voltage		0.7 x V_{CC}	−	5.5	V
I_{OL}	Low level output current	V_{OL} = 0.4 V	3	−	−	mA
I_L	Leakage current	V_I = V_{CC} or V_{SS}	−1	−	+1	μA
C_I (Note 5)	Input capacitance	V_I = V_{SS}	−	−	6	pF
C_O (Note 5)	Output capacitance	V_O = V_{SS}	−	−	8	pF
A0, A1, A2						
V_{IL} (Note 4)	Low level input voltage		−0.5	−	0.8	V
V_{IH} (Note 4)	High level input voltage		2.0	−	5.5	V
I_{LI}	Input leakage current		−1	−	1	μA
I/Os						
V_{IL}	Low level input voltage		−0.5	−	0.8	V
V_{IH}	High level input voltage		2.0	−	5.5	V
I_{OL}	Low level output current	V_{OL} = 0.5 V; V_{CC} = 2.3 V (Note 6)	8	10	−	mA
		V_{OL} = 0.7 V; V_{CC} = 2.3 V (Note 6)	10	13	−	mA
		V_{OL} = 0.5 V; V_{CC} = 4.5 V (Note 6)	8	17	−	mA
		V_{OL} = 0.7 V; V_{CC} = 4.5 V (Note 6)	10	24	−	mA
		V_{OL} = 0.5 V; V_{CC} = 3.0 V (Note 6)	8	14	−	mA
		V_{OL} = 0.7 V; V_{CC} = 3.0 V (Note 6)	10	19	−	mA
V_{OH}	High level output voltage	I_{OH} = −8 mA; V_{CC} = 2.3 V (Note 7)	1.8	−	−	V
		I_{OH} = −10 mA; V_{CC} = 2.3 V (Note 7)	1.7	−	−	V
		I_{OH} = −8 mA; V_{CC} = 3.0 V (Note 7)	2.6	−	−	V
		I_{OH} = −10 mA; V_{CC} = 3.0 V (Note 7)	2.5	−	−	V
		I_{OH} = −8 mA; V_{CC} = 4.75 V (Note 7)	4.1	−	−	V
		I_{OH} = −10 mA; V_{CC} = 4.75 V (Note 7)	4.0	−	−	V
I_{IH}	Input leakage current	V_{CC} = 3.6 V; V_I = V_{CC}	−	−	1	μA
I_{IL}	Input leakage current	V_{CC} = 5.5 V; V_I = V_{SS}	−	−	−100	μA
C_I (Note 5)	Input capacitance		−	−	5	pF
C_O (Note 5)	Output capacitance		−	−	8	pF

4. $V_{IL\ min}$ and $V_{IH\ max}$ are reference values only and are not tested.
5. This parameter is characterized initially and after a design or process change that affects the parameter. Not 100% tested.
6. The total current sunk by all I/Os must be limited to 100 mA and each I/O limited to 25 mA maximum.
7. The total current sourced by all I/Os must be limited to 85 mA.

Table 5. A.C. CHARACTERISTICS (V_{CC} = 2.3 V to 5.5 V; T_A = −40°C to +85°C, unless otherwise specified.) (Note 8)

Symbol	Parameter	Standard I^2C		Fast I^2C		Units
		Min	Max	Min	Max	
F_{SCL}	Clock Frequency		100		400	kHz
$t_{HD:STA}$	START Condition Hold Time	4		0.6		μs
t_{LOW}	Low Period of SCL Clock	4.7		1.3		μs
t_{HIGH}	High Period of SCL Clock	4		0.6		μs
$t_{SU:STA}$	START Condition Setup Time	4.7		0.6		μs
$t_{HD:DAT}$	Data In Hold Time	0		0		μs
$t_{SU:DAT}$	Data In Setup Time	250		100		ns
t_R (Note 9)	SDA and SCL Rise Time		1000		300	ns
t_F (Note 9)	SDA and SCL Fall Time		300		300	ns
$t_{SU:STO}$	STOP Condition Setup Time	4		0.6		μs
t_{BUF} (Note 9)	Bus Free Time Between STOP and START	4.7		1.3		μs
t_{AA}	SCL Low to Data Out Valid		3.5		0.9	μs
t_{DH}	Data Out Hold Time	100		50		ns
T_i (Note 9)	Noise Pulse Filtered at SCL and SDA Inputs		100		100	ns

Symbol	Parameter	Min	Max	Units
PORT TIMING				
t_{PV}	Output Data Valid		200	ns
t_{PS}	Input Data Setup Time	100		ns
t_{PH}	Input Data Hold Time	1		μs
INTERRUPT TIMING				
t_{IV}	Interrupt Valid		4	μs
t_{IR}	Interrupt Reset		4	μs

8. Test conditions according to “AC Test Conditions” table.
9. This parameter is characterized initially and after a design or process change that affects the parameter. Not 100% tested.

Table 6. A.C. TEST CONDITIONS

Input Rise and Fall time	≤ 10 ns
CMOS Input Voltages	0.2 V_{CC} to 0.8 V_{CC}
CMOS Input Reference Voltages	0.3 V_{CC} to 0.7 V_{CC}
TTL Input Voltages	0.4 V to 2.4 V
TTL Input Reference Voltages	0.8 V, 2.0 V
Output Reference Voltages	0.5 V_{CC}
Output Load: SDA, $\overline{INT}$	Current Source I_{OL} = 3 mA; C_L = 100 pF
Output Load: I/Os	Current Source: I_{OL}/I_{OH} = 10 mA; C_L = 50 pF

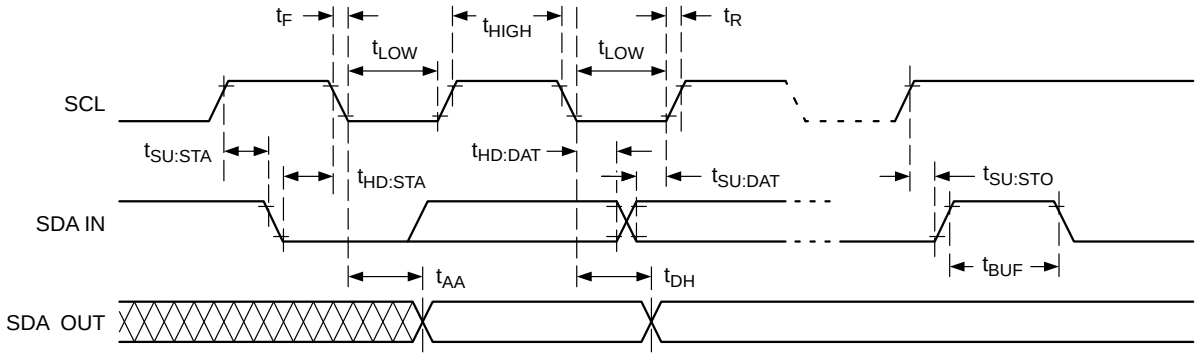


Figure 2. I²C Serial Interface Timing

Pin Description

SCL: Serial Clock

The serial clock input clocks all data transferred into or out of the device. The SCL line requires a pull−up resistor if it is driven by an open drain output.

SDA: Serial Data/Address

The bidirectional serial data/address pin is used to transfer all data into and out of the device. The SDA pin is an open drain output and can be wire−ORed with other open drain or open collector outputs. A pull−up resistor must be connected from SDA line to V_{CC}. The value of the pull−up resistor, R_P, can be calculated based on minimum and maximum values from Figure 3 and Figure 4 (see Note).

A0, A1, A2: Device Address Inputs

These inputs are used for extended addressing capability. The A0, A1, A2 pins should be hardwired to V_{CC} or V_{SS}. When hardwired, up to eight PCA9554s may be addressed on a single bus system. The levels on these inputs are compared with corresponding bits, A2, A1, A0, from the slave address byte.

I/O_0 to I/O_7: Input / Output Ports

Any of these pins may be configured as input or output. The simplified schematic of I/O_0 to I/O_7 is shown in Figure 5. When an I/O is configured as an input, the Q1 and Q2 output transistors are off creating a high impedance input with a weak pull−up resistor (typical 100 kΩ). If the I/O pin is configured as an output, the push−pull output stage is enabled. Care should be taken if an external voltage is applied to an I/O pin configured as an output due to the low impedance paths that exist between the pin and either V_{CC} or V_{SS}.

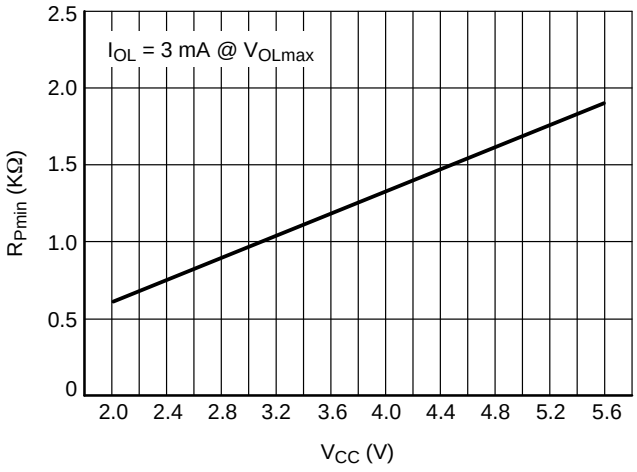


Figure 3. Minimum R_P Value vs. Supply Voltage

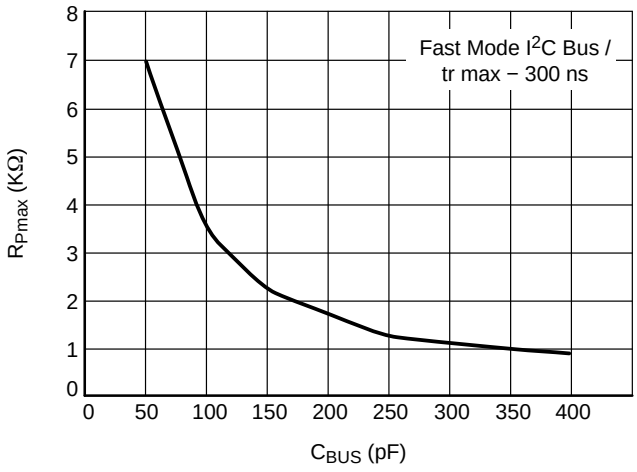


Figure 4. Maximum R_P Value vs. Bus Capacitance

NOTE: According to the Fast Mode I²C bus specification, for bus capacitance up to 200 pF, the pull up device can be a resistor. For bus loads between 200 pF and 400 pF, the pull−up device can be a current source (Imax = 3 mA) or a switched resistor circuit.

$\overline{INT}$: Interrupt Output

The open−drain interrupt output is activated when one of the port pins configured as an input changes state (differs from the corresponding input port register bit state). The interrupt is deactivated when the input returns to its previous state or the input port register is read. Changing an I/O from an output to an input may cause a false interrupt if the state of the pin does not match the contents of the input port register.

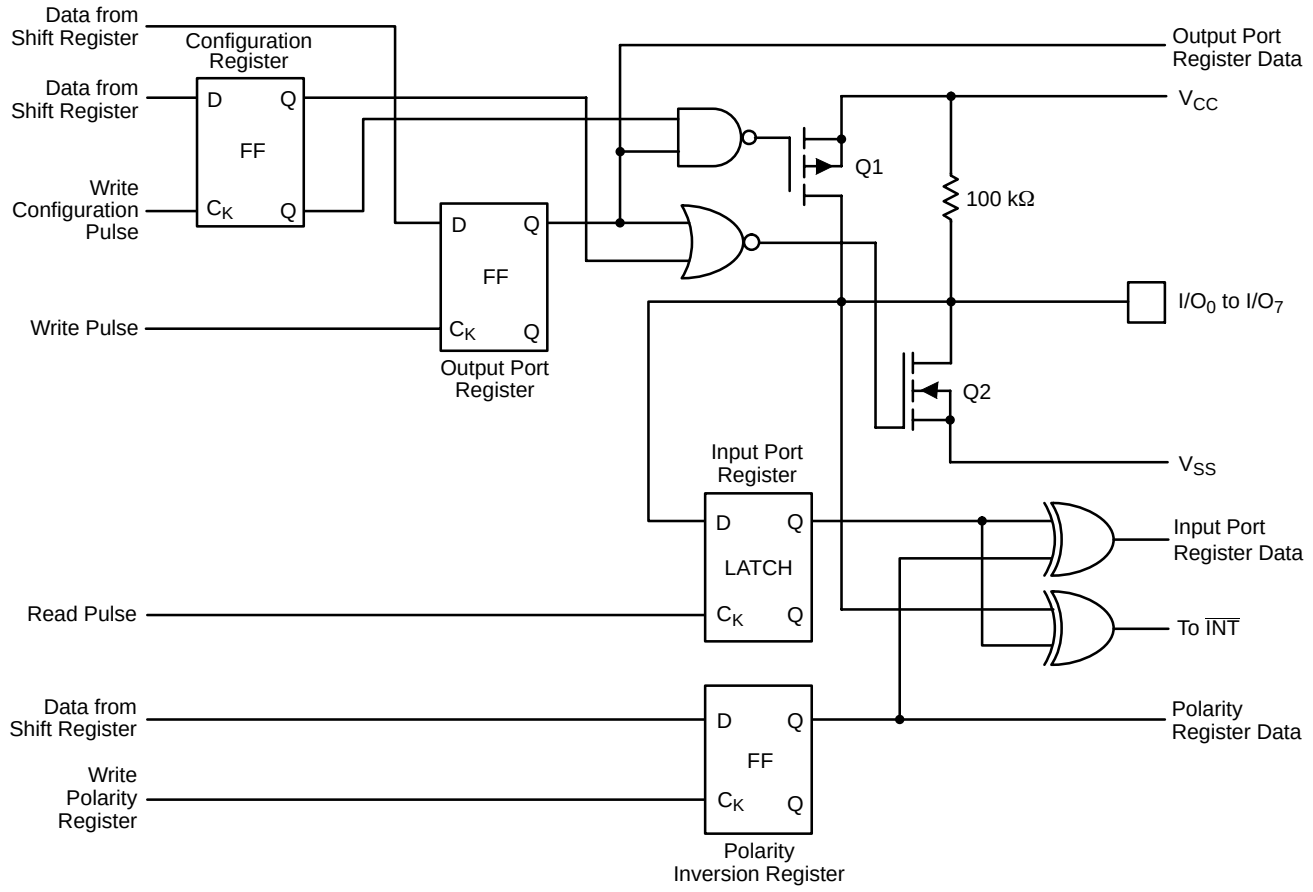


Figure 5. Simplified Schematic of I/O_0 to I/O_7

Functional Description

The PCA9554's general purpose input/output (GPIO) peripherals provide up to eight I/O ports, controlled through an I^2C compatible serial interface.

The PCA9554 supports the I^2C Bus data transmission protocol. This I^2C Bus protocol defines any device that sends data to the bus to be a transmitter and any device receiving data to be a receiver. The transfer is controlled by the Master device which generates the serial clock and all START and STOP conditions for bus access. The PCA9554 operates as a Slave device. Both the Master device and Slave device can operate as either transmitter or receiver, but the Master device controls which mode is activated.

I^2C Bus Protocol

The features of the I^2C bus protocol are defined as follows:

1. Data transfer may be initiated only when the bus is not busy.
2. During a data transfer, the data line must remain stable whenever the clock line is high. Any changes in the data line while the clock line is high will be interpreted as a START or STOP condition (Figure 6).

START and STOP Conditions

The START Condition precedes all commands to the device, and is defined as a HIGH to LOW transition of SDA when SCL is HIGH. The PCA9554 monitors the SDA and SCL lines and will not respond until this condition is met.

A LOW to HIGH transition of SDA when SCL is HIGH determines the STOP condition. All operations must end with a STOP condition.

Device Addressing

After the bus Master sends a START condition, a slave address byte is required to enable the PCA9554 for a read or write operation. The four most significant bits of the slave address are fixed as binary 0100 for the PCA9554 (Figure 7). The PCA9554 uses the next three bits as address bits.

The address bits A2, A1 and A0 are used to select which device is accessed from maximum eight devices on the same bus. These bits must compare to their hardwired input pins. The 8th bit following the 7−bit slave address is the R/$\overline{W}$ bit that specifies whether a read or write operation is to be performed. When this bit is set to "1", a read operation is initiated, and when set to "0", a write operation is selected.

Following the START condition and the slave address byte, the PCA9554 monitors the bus and responds with an acknowledge (on the SDA line) when its address matches the transmitted slave address. The PCA9554 then performs a read or a write operation depending on the state of the R/$\overline{W}$ bit.

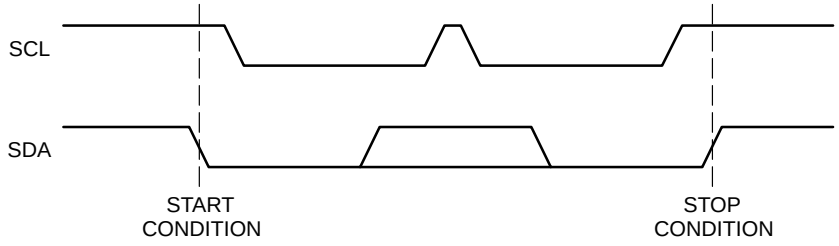


Figure 6. START/STOP Condition

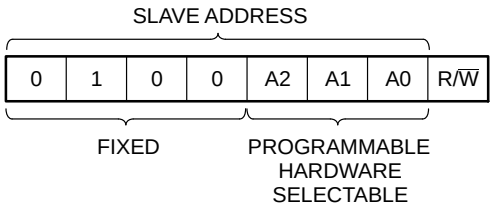


Figure 7. PCA9554 Slave Address

Acknowledge

After a successful data transfer, each receiving device is required to generate an acknowledge. The acknowledging device pulls down the SDA line during the ninth clock cycle, signaling that it received the 8 bits of data. The SDA line remains stable LOW during the HIGH period of the acknowledge related clock pulse (Figure 6).

The PCA9554 responds with an acknowledge after receiving a START condition and its slave address. If the device has been selected along with a write operation, it responds with an acknowledge after receiving each 8−bit byte.

When the PCA9554 begins a READ mode it transmits 8 bits of data, releases the SDA line, and monitors the line for an acknowledge. Once it receives this acknowledge, the PCA9554 will continue to transmit data. If no acknowledge is sent by the Master, the device terminates data transmission and waits for a STOP condition. The master must then issue a STOP condition to return the PCA9554 to the standby power mode and place the device in a known state.

Registers and Bus Transactions

The PCA9554 consists of an input port register, an output port register, a polarity inversion register and a configuration register. Table 7 shows the register address table. Tables 8 to 11 list Register 0 through Register 3 information.

Table 7. REGISTER COMMAND BYTE

Command (hex)	Protocol	Function
0x00	Read byte	Input port register
0x01	Read/write byte	Output port register
0x02	Read/write byte	Polarity inversion register
0x03	Read/write byte	Configuration register

The command byte is the first byte to follow the device address byte during a write/read bus transaction. The register command byte acts as a pointer to determine which register will be written or read.

The input port register is a read only port. It reflects the incoming logic levels of the I/O pins, regardless of whether the pin is defined as an input or an output by the configuration register. Writes to the input port register are ignored.

Table 8. REGISTER 0 – INPUT PORT REGISTER

bit	I_7	I_6	I_5	I_4	I_3	I_2	I_1	I_0
default	1	1	1	1	1	1	1	1

Table 9. REGISTER 1 – OUTPUT PORT REGISTER

bit	O_7	O_6	O_5	O_4	O_3	O_2	O_1	O_0
default	1	1	1	1	1	1	1	1

Table 10. REGISTER 2 – POLARITY INVERSION REGISTER

bit	N_7	N_6	N_5	N_4	N_3	N_2	N_1	N_0
default	0	0	0	0	0	0	0	0

Table 11. REGISTER 3 – CONFIGURATION REGISTER

bit	C_7	C_6	C_5	C_4	C_3	C_2	C_1	C_0
default	1	1	1	1	1	1	1	1

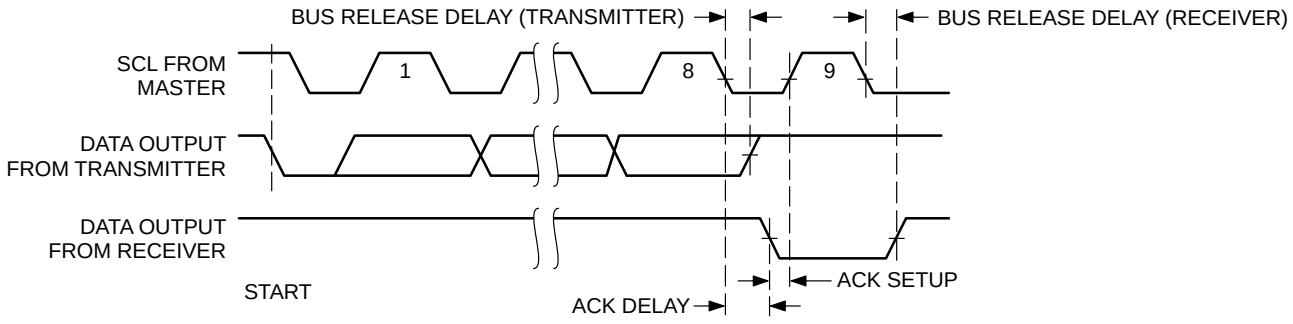


Figure 8. Acknowledge Timing

The output port register sets the outgoing logic levels of the I/O ports, defined as outputs by the configuration register. Bit values in this register have no effect on I/O pins defined as inputs. Reads from the output port register reflect the value that is in the flip−flop controlling the output, not the actual I/O pin value.

The polarity inversion register allows the user to invert the polarity of the input port register data. If a bit in this register is set (“1”) the corresponding input port data is inverted. If a bit in the polarity inversion register is cleared (“0”), the original input port polarity is retained.

The configuration register sets the directions of the ports. Set the bit in the configuration register to enable the corresponding port pin as an input with a high impedance output driver. If a bit in this register is cleared, the corresponding port pin is enabled as an output. At power−up, the I/Os are configured as inputs with a weak pull−up resistor to V_{CC}.

Data is transmitted to the PCA9554’s registers using the write mode shown in Figure 9 and Figure 10.

The PCA9554’s registers are read according to the timing diagrams shown in Figure 11 and Figure 12. Once a command byte has been sent, the register which was addressed will continue to be accessed by reads until a new command byte will be sent.

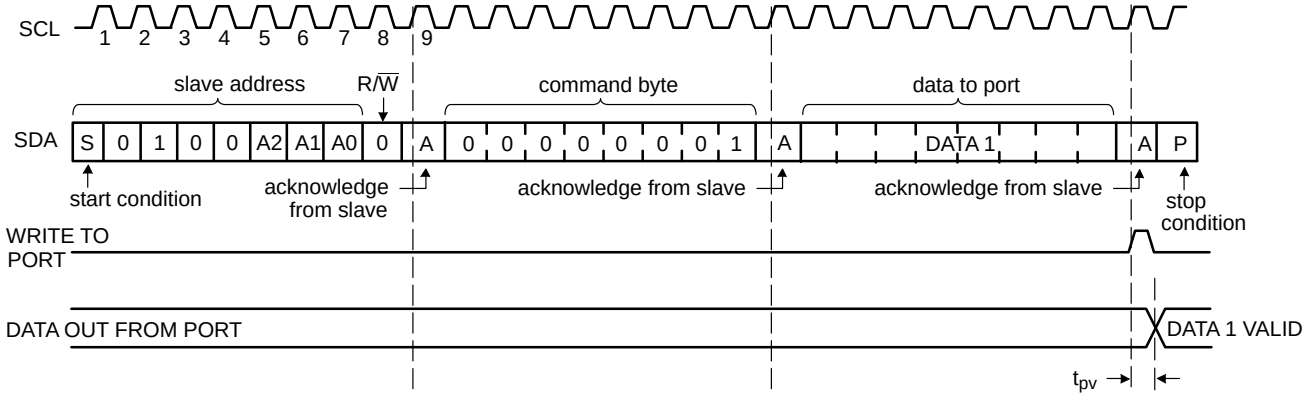


Figure 9. Write to Output Port Register

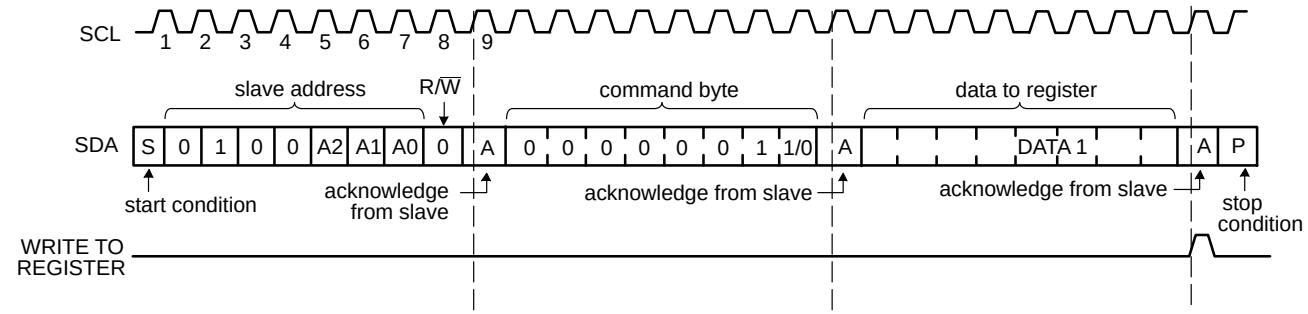


Figure 10. Write to Configuration or Polarity Inversion Register

Power−On Reset Operation

When the power supply is applied to V_{CC} pin, an internal power−on reset pulse holds the PCA9554 in a reset state until V_{CC} reaches V_{POR} level. At this point, the reset condition is released and the internal state machine and the PCA9554's registers are initialized to their default state.

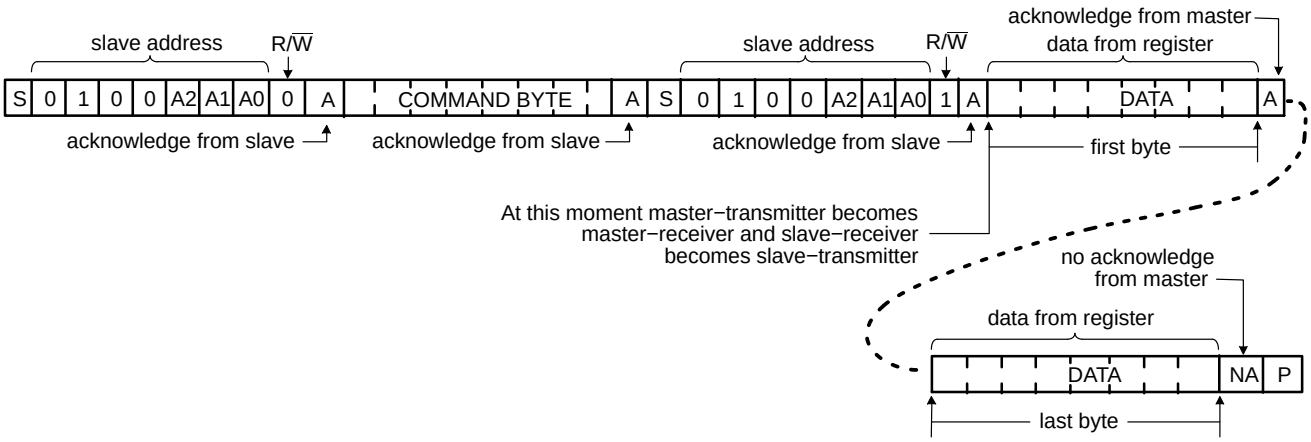


Figure 11. Read from Register

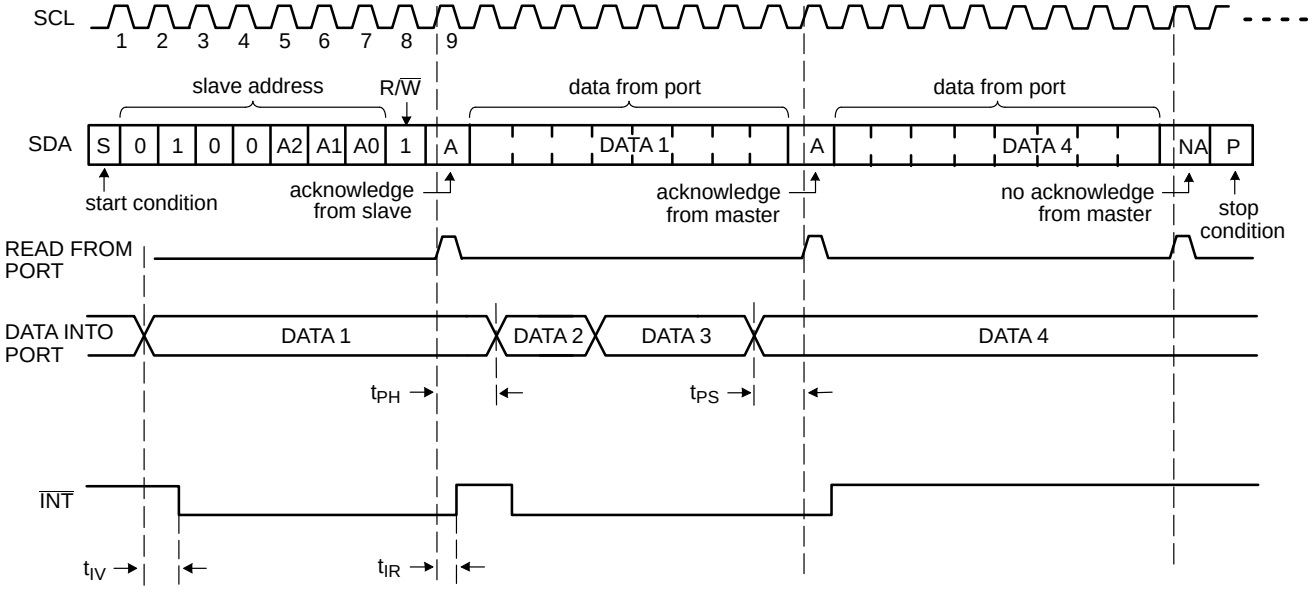
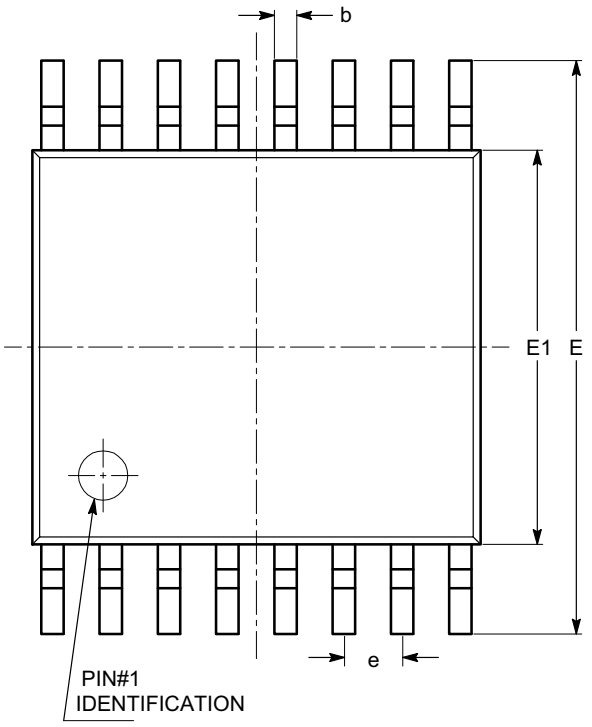


Figure 12. Read Input Port Register

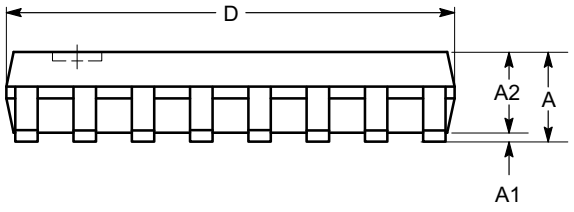
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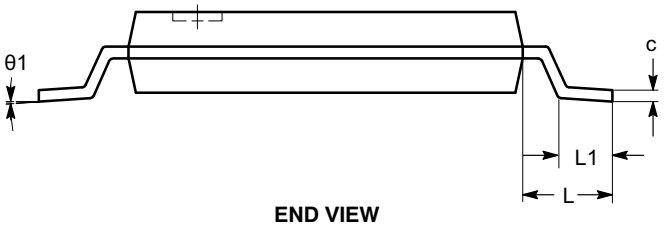


TOP VIEW

SYMBOL	MIN	NOM	MAX
A			1.10
A1	0.05		0.15
A2	0.85		0.95
b	0.19		0.30
c	0.13		0.20
D	4.90		5.10
E	6.30		6.50
E1	4.30		4.50
e	0.65 BSC		
L	1.00 REF		
L1	0.45		0.75
θ	0º		8º



SIDE VIEW



END VIEW

Notes:
(1) All dimensions are in millimeters. Angles in degrees.
(2) Complies with JEDEC MO-153.

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